Declaration for U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural

				or which a patent is soug e specification of which		
1 X 1	ns filed on <u>June 30, 20</u> CT/JP00/04392 and		-	oplication Number or PCT	Γ International Alicable).	Application Number
•	nave reviewed and unde endment referred to abo		ntents of th	e above-identified specif	ication, includin	ng the claim(s), as
I acknowledge the du \$ 1.56.	uty to disclose informati	on which is r	naterial to	patentability as defined in	n Title 37, Code	of Federal Regulations,
inventor's certificate		lso identified	l below any	Code, § 119 (a) - (d) of a foreign application for pd:		
					Priority Claim	ned
(List prior					Yes	No
foreign	(Number)	(Country)	(Day	/Month/Year Filed)	37	NI -
hpplications. See note A on	(Number)	(Country)	/Day	/Month/Year Filed)	Yes	N0
back of this	(Number)	(Country)	(Da)	//Wiolitiv Teal Thea)	Yes	No
Lpage)	(Number)	(Country)	(Day	/Month/Year Filed)		
1 1	,			·	Yes	No
u.	(Number)	(Country)	(Day	/Month/Year Filed)		
See note B on back	of this page)	See atta	ched list fo	or additional prior foreign	applications	
subject matter of eac the first paragraph of as defined in Title 37	th of the claims of this a Title 35, United States C	pplication is r Code, § 112, I rlations, § 1.5	not disclose acknowled 6 which be	of any United States applied in the prior United Stage the duty to disclose infecame available between	tes application i ormation which	n the manner provided b is material to patentabilit
(List Prior U.S.						
Applications)	(Appln. Serial No.)	(Filing	Date)	(Status: Patented, Pend	ing, Abandoned	1)
	(Appln. Serial No.)	(Filing	Date)	(Status: Patented, Pending, Abandoned)		
	(Appln. Serial No.)	(Filing	g Date)	(Status: Patented, Pend	ing, Abandoned	i)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



ATENT TO A DEMANY OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C	Full name of sole or first inventor (given name, family name) Naoki MORITA					
above)	Inventor's signature <u>hashi Morita</u> Date <u>JAN. 24. 2002</u>					
11.00 21.00 21.00	Residence Yamatokoriyama-shi, Japan TPX Citizenship Japan					
	Post Office Addressc/o MORI SEIKI CO., LTD.					
B-07	106, Kitakorivama-cho, Yamatokoriyama-shi, Nara, 639-1160, Japan					
F嗣 name of second in	nventor (given name, family name) Yasushi FUKAYA					
	Yasushi Fukaya Date Jan 31,2002					
N	wa-gun, Japan TR Citizenship Japan					
II III Post Office Address _	c/o OKUMA CORPORATION, Oguchi Kojo					
<u> </u>	25-1, Shimo-Koguchi 5-chome, Oguchi-cho, Niwa-gun, Aichi 480-0193, Japan					
3-00						
Full name of second in	nventor (given name, family name) <u>Kazuo YAMAZAKI</u>					
Inventor's signature	<u> Z. Home</u> Date Jon 26, 2002					
Residence : Sa	acramento, California CH Citizenship Japan					
Post Office Address	1500 7th Street #7.0 Secremento California 95814 II S A					